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EA3036

General Description

The EA3036C is a 3CH power management IC for applications powered by one Li-Ion battery or a DC 5V adapter. It integrates three synchronous buck converters and can provide high efficiency output at light load and heavy load operation. The internal compensation architecture simplifies the application circuit design. Besides, the independent enable control makes the designer have the greatest flexibility to optimize timing for power sequencing purposes. The EA3036C is available in a 20 pin QFN 3x3 package.

Features

- 2.7V to 5.5V Input Voltage Range
- Three Buck Converters

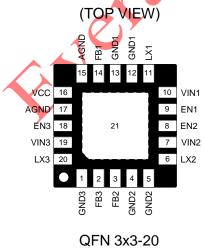
 Output Voltage Range: 0.6V to Vin
 Continuous Load Current:1A (3CH total output power consumption must be less than 6W)
 Fixed 1.5MHz Switching Frequency
 100% Duty Cycle Low Dropout Operation
 <1uA Shutdown Current
 Independent Enable Control
 Internal Compensation
 Cycle-by-Cycle Current Limit
 Short Circuit Protection

 Auto Recovery OTP Protection
- Input OVP Architecture
- Available in 20-pin 3mm x 3mm QFN Package

Applications

- Smart Phone
- IP Camera
- Digital Camera

Pin Configurations



3CH Power Management IC

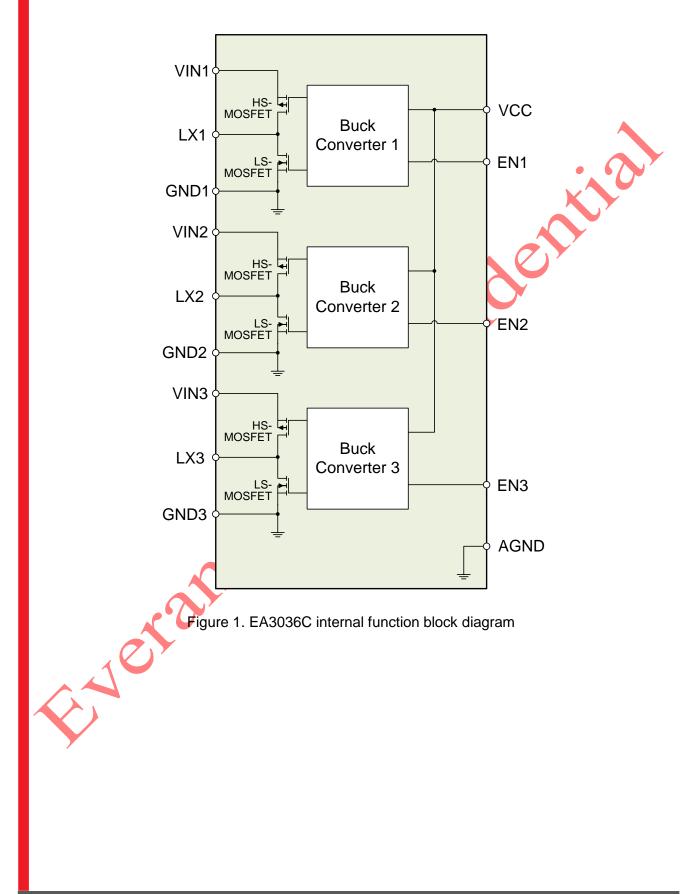
Ver. 1.4

Pin Description

Pin Name	Function Description	Pin No.
GND3	Power ground pin of CH3.	1
FB3	Feedback input of CH3. Connect to output voltage with a resistor divider.	2
FB2	Feedback input of CH2. Connect to output voltage with a resistor divider.	3
GND2	Power ground pin of CH2.	4, 5
LX2	Internal MOSFET switching output of CH2. Connect LX2 pin with a low pass filter circuit to obtain a stable DC output voltage.	6
VIN2	Power input pin of CH2. Recommended to use a 10uF MLCC capacitor between VIN2 pin and GND2 pin.	7
EN2	CH2 turns on/turns off control input. Don't leave this pin floating.	8
EN1	CH1 turns on/turns off control input. Don't leave this pin floating.	9
VIN1	Power input pin of CH1. Recommended to use a 10uF MLCC capacitor between VIN1 pin and GND1 pin.	10
LX1	Internal MOSFET switching output of CH1. Connect LX1 pin with a low pass filter circuit to obtain a stable DC output voltage.	11
GND1	Power ground pin of CH1.	12, 13
FB1	Feedback input of CH1. Connect to output voltage with a resistor divider.	14
AGND	Analog ground pin.	15, 17
VCC	Input supply pin for internal control circuit.	16
EN3	CH3 turns on/turns off control input. Don't leave this pin floating.	18
VIN3	Power input pin of CH3. Recommended to use a 10uF MLCC capacitor between VIN3 pin and GND3 pin.	19
LX3	Internal MOSEET switching output of CH3. Connect SW3 pin with a low pass filter circuit to obtain a stable DC output voltage.	20
Exposed Pad	The Exposed Pad must be soldered to a large PCB copper plane and connected to GND for appropriate dissipation.	21

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Function Block Diagram



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Datasheet

Absolute Maximum Ratings

Parameter	Value
Input Voltage (V_{VIN1} , V_{VIN2} , V_{VIN3} , V_{VCC})	-0.3V to +8V
SW Pin Voltage (V _{LX1} , V _{LX2} , V _{LX3})	-0.3V to V_{VINX} +0.3V
All Other Pins Voltage	-0.3V to +6.5V
Ambient Temperature operating Range (T _A)	-40°C to +85°C
Maximum Junction Temperature (T _{Jmax})	+150°C
Lead Temperature (Soldering, 10 sec)	+260°C
Storage Temperature Range (T _s)	-65°C to +150°C
Note (1) Stresses haven these listed under "Absolute Maximum Datings"	may aques normanant domate to the device

Note (1):Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to "Absolute Maximum Ratings" conditions for extended periods may affect device reliability and lifetime.

Package Thermal Characteristics

Parameter		Value
QFN 3x3-20 Thermal Resistance (θ_{JC})		7.5°C/W
QFN 3x3-20 Thermal Resistance (θ_{JA})		67°C/W
QFN 3x3-20 Power Dissipation at $T_A=25^{\circ}C$ (P_D	1.87W	

Note (1): P_{Dmax} is calculated according to the formula: $P_{DMAX}=(T_{JMAX}-T_A)/\theta_{JA}$.

Recommended Operating Conditions

Parameter	Value	
Input Voltage (V _{VIN1} , V _{VIN2} , V _{VIN3} , V _{VCC})	+2.7V to +5.5V	
Junction Temperature Range (T _J)	-40°C to +125°C	

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Electrical Characteristics

 V_{VINX} =5V, V_{VCC} =5V, T_A =25°C, unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input Supply Voltage						
Input Voltage	V _{INX}		2.7		5.5	V
Control Circuit Input Voltage	V _{VCC}		2.7		5.5	V
Input Supply Current					• 6	
Shutdown Current	I _{SD-total}	$V_{ENX} = 0V$		0.2	x1	uA
Quiescent Current	I _{Q-total}	$V_{FB1} = V_{FB2} = V_{FB3}$ $= 1V$		185	250	uA
No Load Current	I _{NL-total}	$I_{LOAD1} = I_{LOAD2} = I_{LOAD3} = 0A$. ^	230	280	uA
Buck Converter 1, 2, 3						
UVLO Threshold	V_{UVLO}	V _{VIN} Rising	1.7	1.9	2.1	V
UVLO Hysteresis	$V_{\text{UV-HYST}}$			0.1		V
Output Load Current	I LOAD			1	1.5	А
Reference Voltage	V_{REF}		0.588	0.6	0.612	V
Switching Frequency	F_{SW}	I _{LOAD} = 300mA	1	1.5	2	MHz
Short Frequency	F _{SW-SHORT}	V _{OUT} = 0V		400		KHz
PMOS Current Limit	I _{LIM-P}		1.8	2.2		А
PMOS On-Resistance	R _{DS(ON)-P}	$I_{LOAD} = 100 \text{mA}$		120		mΩ
NMOS On-Resistance	R _{DS(ON)-N}	$I_{LOAD} = 100 \text{mA}$		110		mΩ
Enable Pin Input Low Voltage	V _{EN-L}				0.4	V
Enable Pin Input High Voltage	$V_{\text{EN-H}}$		1.4			V
Maximum Duty Cycle	D _{MAX}		100			%
Input OVP Threshold Voltage	V _{OVP}	V_{IN} rising		6.3		V
Input OVP Threshold Hysteresis	V _{OVP-HYST}			150		mV
Thermal Shutdown						
Thermal Shutdown Threshold	T _{OTP}			165		°C
Thermal Shutdown Hysteresis	T _{HYST}			30		°C

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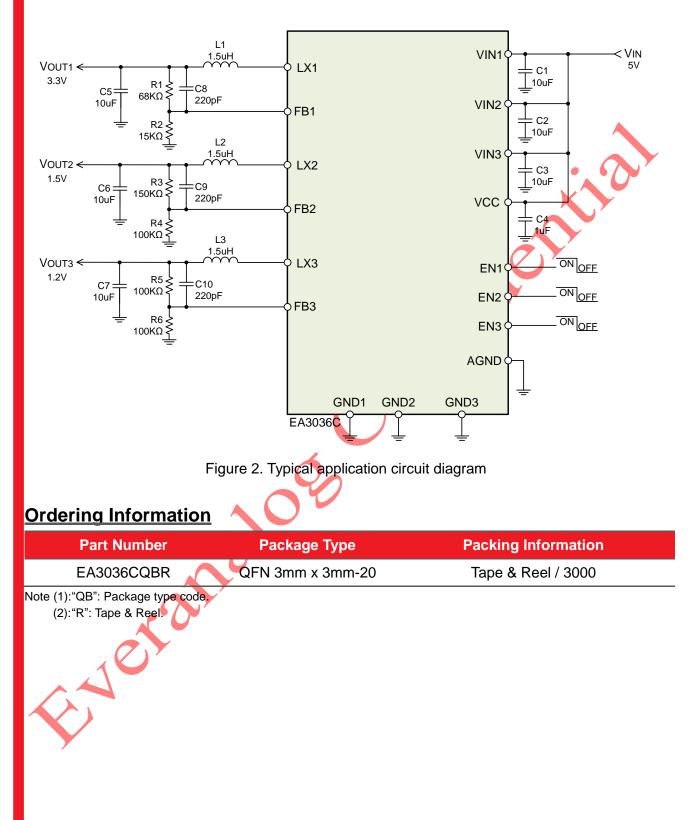
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Note (1): MOSFET on-resistance specifications are guaranteed by correlation to wafer level measurements. (2): Thermal shutdown specifications are guaranteed by correlation to the design and characteristics analysis.

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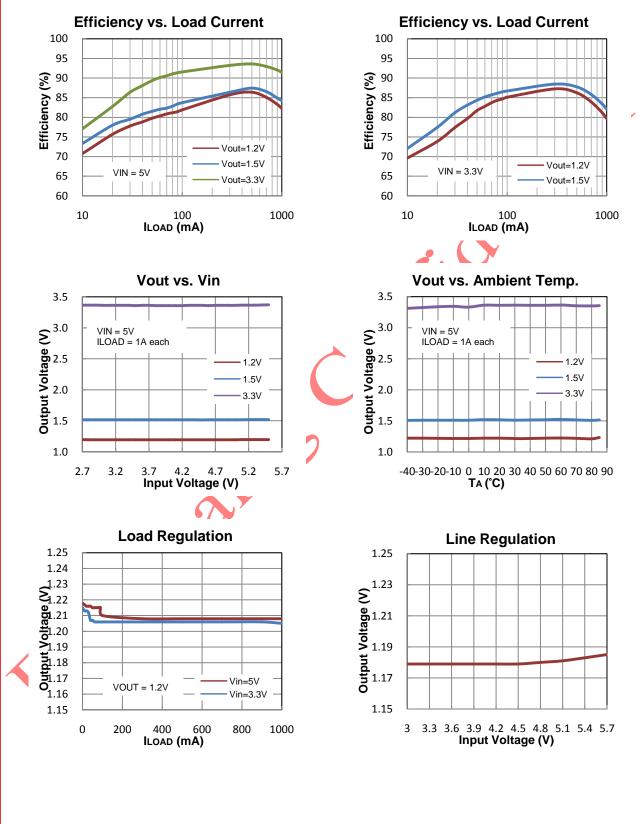
Application Circuit Diagram



3CH Power Management IC

Typical Operating Characteristics

 V_{IN} =5V, V_{VCC} =5V, V_{OUT1} =3.3V, V_{OUT2} =1.5V, V_{OUT3} =1.2V, L1=1.5uH, L2=1.5uH, L3=1.5uH, T_A=25°C, unless otherwise noted



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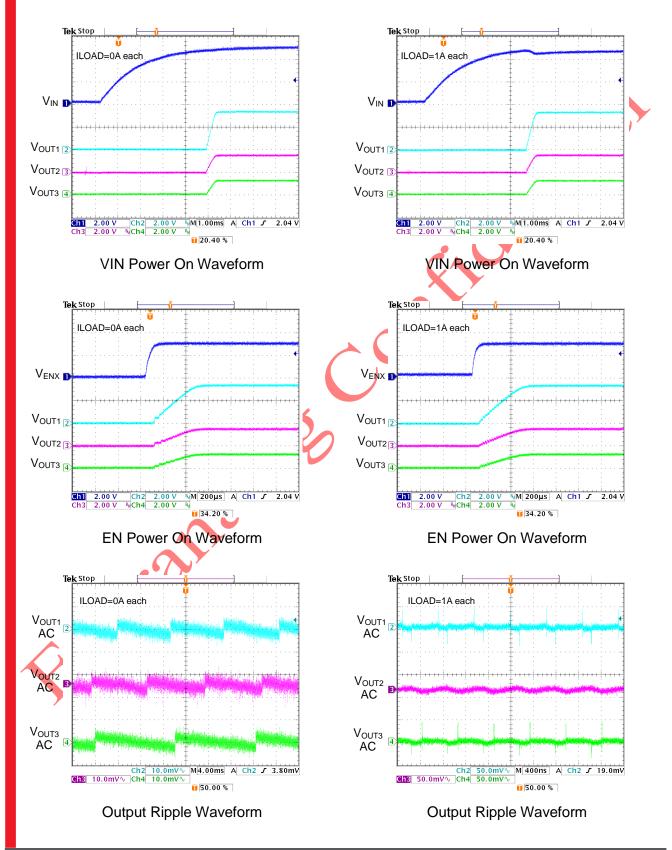


Datasheet

3CH Power Management IC

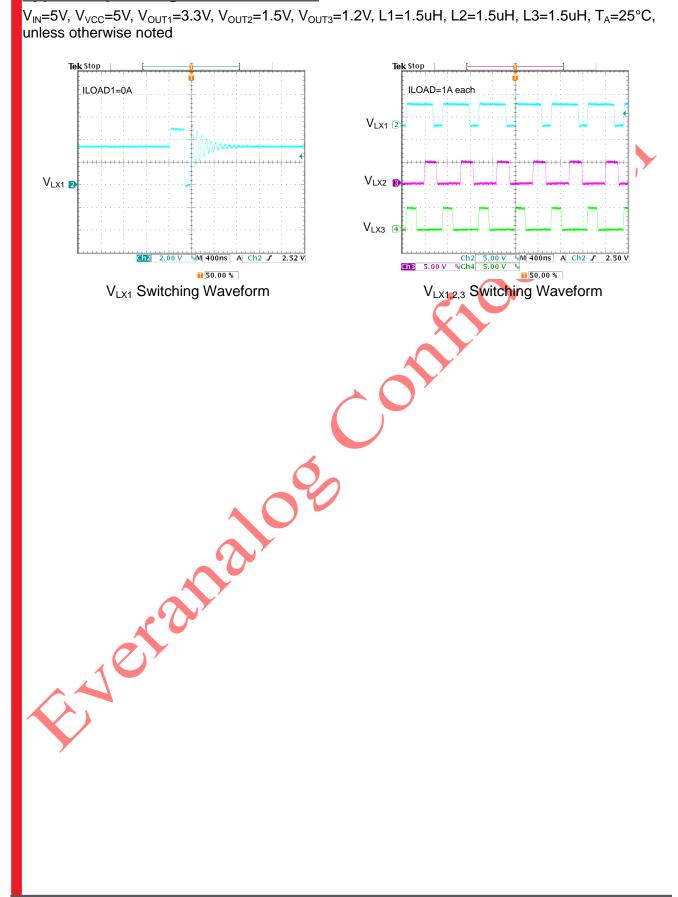
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3CH Power Management IC

Typical Operating Characteristics





EA3036C 3CH Power Management IC

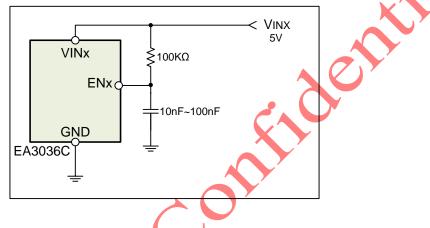
Functional Description

PFM/PWM Operation

Each of the buck regulators can be operated at PFM/PWM mode. If the output current is less than 260mA (typ.), the regulators automatically enters the PFM mode. The output voltages and output ripples at PFM mode are higher than the output voltages and output ripples at PWM mode. But at very light load, the PFM mode operation provides higher efficiency than PWM mode operation.

Enable Control

The EA3036C is a high efficiency Power Management IC which is designed for IPC applications. It incorporates three 1A synchronous buck regulators and can be controlled by individual EN pins. The start-up time for each channel can be programmed by using the circuit shown as below:



180° Phases Shifted Architecture

In order to reduce the input ripple current, the EA3036C applied 180° phases shifted architecture. Buck1 and Buck3 have the same phase and Buck2 is 180° out of phase. This architecture allows the system board has less ripple current, and thus can reduce EMI.

Over Current Protection

The EA3036C internal three regulators have their own cycle-by-cycle current limit circuits. When the inductor peak current exceeds the current limit threshold, the output voltage starts to drop until FB pin voltage is below the threshold, typically 30% below the reference. Once the threshold is triggered, the switching frequency is reduced to 400KHz (typ.).

Peak Load Current

The EA3036C peak load current capability is determined by the internal PMOS current limit, the work duty (Vout/Vin) and the inductance value. For Vin=5V, L=1.5uH condition, the output peak load current capability is shown as below:

Output Voltage	Peak Load Current
3.3V	1.2A
1.8V	1.5A
1.5V	1.5A
1.2V	1.5A

It is must be remined that the total output power consumption must be less than 6W to avoid the chip be damaged by overheating.

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Thermal Shutdown

The EA3036C will automatically disabled if the die temperature is higher than the thermal shutdown threshold point. To avoid unstable operation, the hysteresis of thermal shutdown is about 30°C.





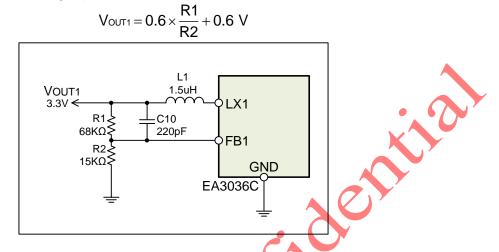


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Application Information

Output Voltage Setting

Each of the regulators output voltage can be set via a resistor divider (ex. R1, R2). The output voltage is calculated by following equation:



The following table lists common output voltage and the corresponding R1, R2 resistance value for reference.

Output Voltage	R1 Resistance	R2 Resistance	Tolerance	
3.3V	68ΚΩ	15ΚΩ	1%	
1.8V	200ΚΩ	100ΚΩ	1%	
1.5V	150ΚΩ	100ΚΩ	1%	
1.2V	100ΚΩ	100ΚΩ	1%	

Input / Output Capacitors Selection

The input capacitors are used to suppress the noise amplitude of the input voltage and provide a stable and clean DC input to the device. Because the ceramic capacitor has low ESR characteristic, so it is suitable for input capacitor use. It is recommended to use X5R or X7R MLCC capacitors in order to have better temperature performance and smaller capacitance tolerance. In order to suppress the output voltage ripple, the MLCC capacitor is also the best choice. The suggested part numbers of input / output capacitors are as follows:

Vendor	Part Number	Capacitance	Edc	Parameter	Size
TDK	C2012X5R1A106M	10uF	10V	X5R	0805
TDK	C3216X5R1A106M	10uF	10V	X5R	1206
TDK	C2012X5R1A226M	22uF	10V	X5R	0805
TDK	C3216X5R1A226M	22uF	10V	X5R	1206

Output Inductor Selection

The output inductor selection mainly depends on the amount of ripple current through the inductor ΔI_{L} . Large ΔI_{L} will cause larger output voltage ripple and loss, but the user can use a smaller inductor to save cost and space. On the contrary, the larger inductance can get smaller ΔI_{L} and

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thus the smaller output voltage ripple and loss. But it will increase the space and the cost. The inductor value can be calculated as:

$$L = \frac{V_{PWR} - V_{OUT}}{\Delta I_L \times F_{SW}} \times \frac{V_{OUT}}{V_{PWR}}$$

For most applications, 1.0uH to 2.2uH inductors are suitable for EA3036C.

Power Dissipation

The total output power dissipation of EA3036C should not to exceed the maximum 6W range. The total output power dissipation can be calculated as:

 $P_{D}(\mathsf{total}) = V_{OUT1} \times I_{OUT1} + V_{OUT2} \times I_{OUT2} + V_{OUT3} \times I_{OUT3}$

PCB Layout Recommendations

Layout is very critical for PMIC designs. For EA3036C PCB layout considerations, please refer to the following suggestions to get best performance.

- It is suggested to use 4-layer PCB layout and place LX plane and output plane on the top layer, place VIN plane in the inner layer.
- The top layer SMD input and output capacitors ground plane should be connected to the internal ground layer and bottom ground plane individually by using vias.
- The AGND should be connected to inner ground layer directly by using via.
- High current path traces need to be widened.
- Place the input capacitors as close as possible to the VINx pin to reduce noise interference.
- Keep the feedback path (from V_{OUTX} to FBx) away from the noise node (ex. LXx). LXx is a high current noise node. Complete the layout by using short and wide traces.
- The top layer exposed pad ground plane should be connected to the internal ground layer and bottom ground plane by using a number of vias to improve thermal performance.
- Place the input capacitors as close as possible to the VINx pin to reduce noise interference.





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